AUIRFI4905

HEXFET[®] Power MOSFET

Features

- Advanced Planar Technology
- P-Channel MOSFET

International

IOR Rectifier

- Low On-Resistance
- Dynamic dV/dT Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Repetitive Avalanche Allowed up to Tjmax
- Lead-Free, RoHS Compliant
- Automotive Qualified *

Description

Specifically designed for Automotive applications, this cellular design of HEXFET[®] Power MOSFETs utilizes the latest processing techniques to achieve low on-resistance per silicon area. This benefit combined with the fast switching speed an ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in Automotive and a wide variety of other applications.

s	

D	V _{DSS}	-55V
/)	R _{DS(on)} max.	20m Ω
s	I _{D (Silicon Limited)}	-39A



G	D	S
Gate	Drain	Source

Base Part Number	Package Type	Standard Pack		Orderable Part Number
		Form	Quantity	
AUIRFI4905	TO-220 Full-Pak	Tube	50	AUIRFI4905

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (TA) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
I _D @ T _{C (Bottom)} = 25°C	Continuous Drain Current, V _{GS} @ -10V (Silicon Limited)	-39	
I _D @ T _{C (Bottom)} = 100°C	-27	А	
I _{DM}	Pulsed Drain Current ①	-155	
P _D @T _{C (Bottom)} = 25°C	Power Dissipation	55	W
	Linear Derating Factor	0.37	W/°C
V _{GS}	Gate-to-Source Voltage	± 20	V
E _{AS}	Single Pulse Avalanche Energy (Thermally Limited) 2	1247	mJ
I _{AR}	Avalanche Current ①	See Fig. 14, 15, 22a, 22b	А
E _{AR}	Repetitive Avalanche Energy ①		
TJ	Operating Junction and	-55 to + 175	°C
T _{STG}	Storage Temperature Range		C

Thermal Resistance

Symbol	Parameter	Тур.	Max.	Units
$R_{ ext{ heta}JC}$	Junction-to-Case ©		2.73	°C/W
$R_{ ext{ heta}JA}$	Junction-to-Ambient		65	

HEXFET® is a registered trademark of International Rectifier. *Qualification standards can be found at <u>http://www.irf.com/</u>

Static Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	-55			V	V _{GS} = 0V, I _D = -250µA
$\Delta V_{(BR)DSS} / \Delta T_J$	Breakdown Voltage Temp. Coefficient		-0.049		V/°C	Reference to 25° C, I _D = -1.0mA
R _{DS(on)}	Static Drain-to-Source On-Resistance			20	mΩ	$V_{GS} = -10V, I_{D} = -23A$ (4)
V _{GS(th)}	Gate Threshold Voltage	-2.0		-4.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
gfs	Forward Transconductance	17			S	$V_{DS} = -10V, I_{D} = -23A$
	Drain to Course Looke as Current			-25		$V_{DS} = -55V, V_{GS} = 0V$
DSS	Drain-to-Source Leakage Current			-250	μA	$V_{DS} = -44V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			100	n A	$V_{GS} = 20V$
	Gate-to-Source Reverse Leakage			-100	nA	$V_{GS} = -20V$

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
Q_{g}	Total Gate Charge		110	165		I _D = -23A
Q_{gs}	Gate-to-Source Charge		18		nC	$V_{DS} = -44V$
Q_{gd}	Gate-to-Drain ("Miller") Charge		51			V _{GS} = -10V ④
t _{d(on)}	Turn-On Delay Time		14			$V_{DD} = -55V$
t _r	Rise Time		45		ns	I _D = -23A
t _{d(off)}	Turn-Off Delay Time		71			$R_G = 2.7\Omega$
t _f	Fall Time		61			V _{GS} = -10V ④
L _D	Internal Drain Inductance		4.5			Between lead,
					nH	6mm (0.25in.)
L _S	Internal Source Inductance		7.5			from package
						and center of die contact
C _{iss}	Input Capacitance		3560			$V_{GS} = 0V$
C _{oss}	Output Capacitance		1290		pF	V _{DS} = -25V
C _{rss}	Reverse Transfer Capacitance		480			<i>f</i> = 1.0 MHz
Diode Charac	cteristics					
Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
	Continuous Source Current			-39	А	MOSFET symbol
IS	(Body Diode)				A	showing the
	Pulsed Source Current			-155	^	integral reverse
ISM	(Body Diode) ①				A	p-n junction diode.
V _{SD}	Diode Forward Voltage			-1.6	V	$T_J = 25^{\circ}C, I_S = -23A, V_{GS} = 0V$ (4)

2.8

64

164

ns

nC

Notes:

dv/dt

Qrr

Peak Diode Recovery 3

Reverse Recovery Time

Reverse Recovery Charge

- $\$ R_{θ} is measured at T_J approximately 90°C.

V/ns $T_J = 175^{\circ}C$, $I_S = -23A$, $V_{DS} = -55V$

di/dt = 100A/µs④

T_J = 25°C, I_F = -23A, V_R = -28V

 $[\]ensuremath{\mathbb O}$ Repetitive rating; pulse width limited by max. junction temperature.

[@] Limited by $T_{Jmax},$ starting T_J = 25°C, L = 4.7mH, R_G = 50 $\Omega,$ I_{AS} = -23A, V_{GS} =-10V.



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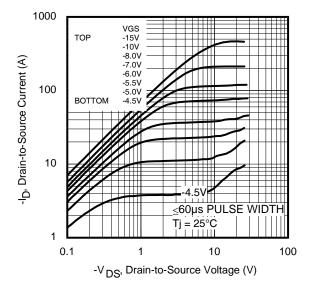
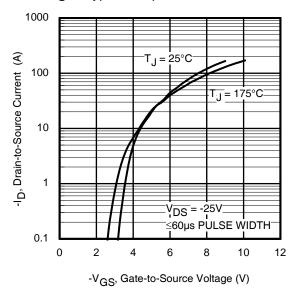


Fig. 1 Typical Output Characteristics





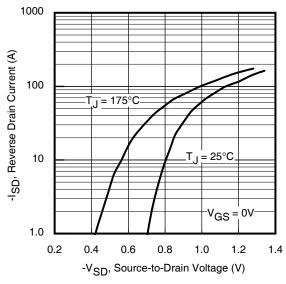


Fig. 5 Typical Source-to-Drain Diode Forward Voltage

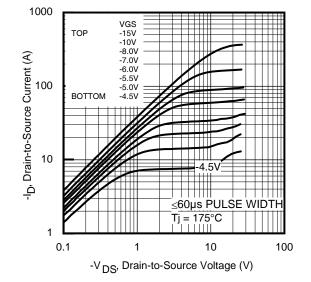
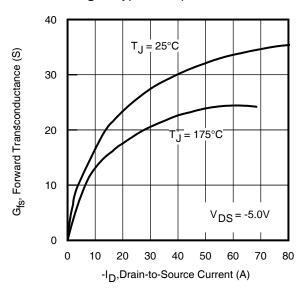


Fig. 2 Typical Output Characteristics





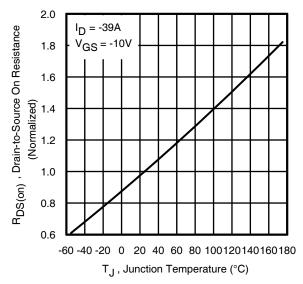
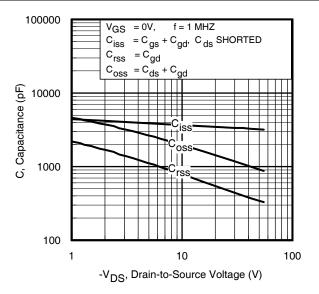
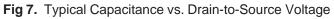


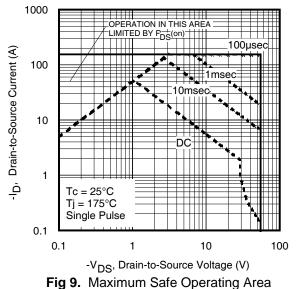
Fig. 6 Normalized On-Resistance vs. Temperature

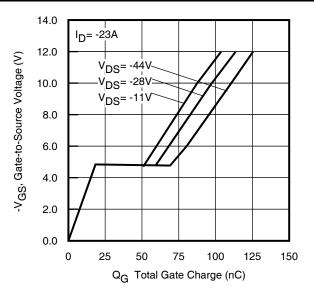
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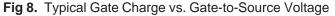












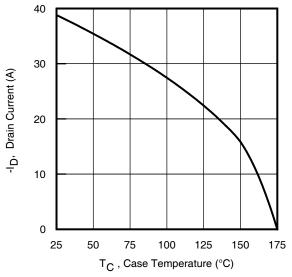


Fig 10. Maximum Drain Current vs. Case Temperature

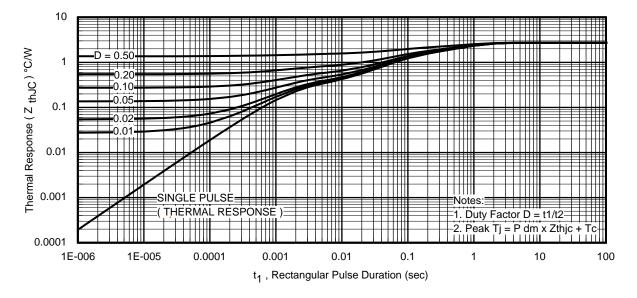
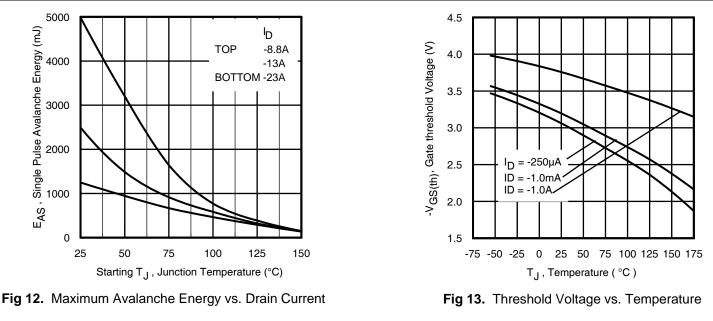


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

4





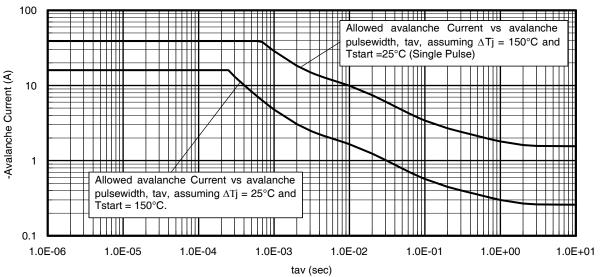


Fig 14. Typical Avalanche Current vs. Pulse Width

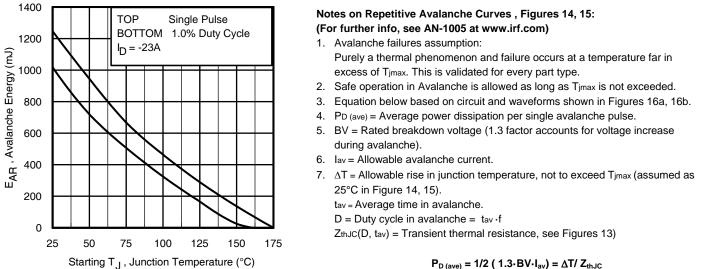
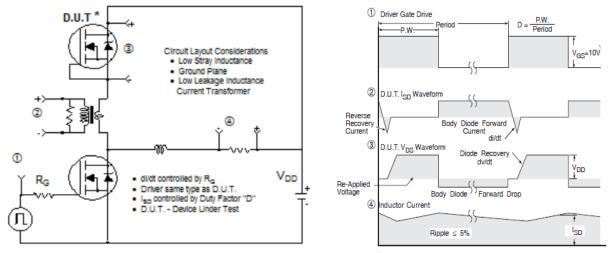


Fig 15. Maximum Avalanche Energy vs. Temperature

$$\begin{split} P_{D (ave)} &= 1/2 \ (\ 1.3 \cdot BV \cdot I_{av}) = \Delta T/ \ Z_{thJC} \\ I_{av} &= 2\Delta T/ \ [1.3 \cdot BV \cdot Z_{th}] \\ E_{AS (AR)} &= P_{D (ave)} \cdot t_{av} \end{split}$$

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* Reverse Polarity of D.U.T for P-Channel

* V_{GS} = 5V for Logic Level Devices

Fig 16. Peak Diode Recovery dv/dt Test Circuit for P-Channel HEXFET® Power MOSFETs

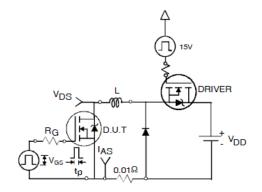


Fig 17a. Unclamped Inductive Test Circuit

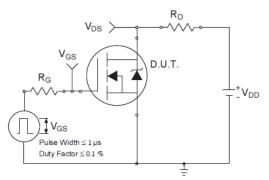


Fig 18a. Switching Time Test Circuit

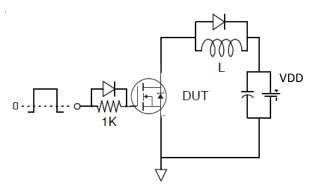


Fig 19a. Gate Charge Test Circuit

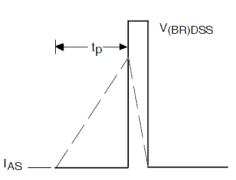


Fig 17b. Unclamped Inductive Waveforms

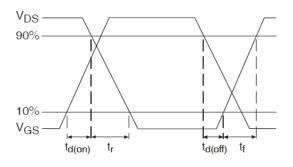


Fig 18b. Switching Time Waveforms

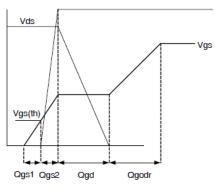


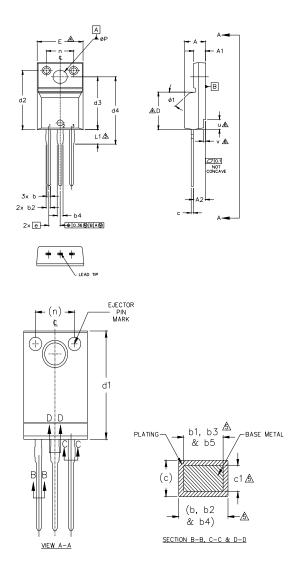
Fig 19b. Gate Charge Waveform

ld



TO-220 Full-Pak Package Outline

Dimensions are shown in millimeters (inches)



NOTES:

- 1.0 DIMENSIONING AND TOLERANCING AS PER ASME Y14.5 M- 1994.
- 2,0 DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 1. LEAD DIMENSION AND FINISH UNCONTROLLED IN L1.
- A.D DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTER MOST A EXTREMES OF THE PLASTIC BODY.
- DIMENSION 61, 63, 65 & c1 APPLY TO BASE METAL ONLY.
- 6. STEP OPTIONAL ON PLASTIC BODY DEFINED BY DIMENSIONS u & v.
- 7.0 CONTROLLING DIMENSION : INCHES.

S Y M	DIMENSIONS					
В	MILLIM	ETERS	INC	HES	0 T	
0 L	MIN.	MAX.	MIN.	MAX.	E S	
А	4.57	4.83	.180	.190		
A1	2.57	2.83	.101	.111		
A2	2.41	2.92	.095	.115		
b	0.62	.094	0.24	.037		
b1	0.62	0.89	.024	0.35	5	
b2	0.76	1.27	.030	.050		
b3	0.76	1.22	.030	.048	5	
b4	1.02	1.52	.040	.060		
b5	1.02	1.47	.040	.058	5	
с	0.33	0.63	.013	.025		
c1	0.33	0.58	.013	.023	5	LE.
D	8.65	9.80	.341	.386	4	
d1	15.80	16.12	.622	.635		
d2	13.97	14.22	.550	.560		
d3	12.30	12.92	.484	.509		
d4	8.64	9.91	.340	.390		
Ε	9.63	10.63	.379	.419	4	
е		BSC	.100	BSC		
L	13.20	13.72	.520	.540		
L1	3.10	2.31	.122	.138	3	
n	6.05	6.15	.238	.242		
ØΡ	3.05	3.45	.120	.136		
u	2.40	2.50	.094	.098	6	
v	0.40	0.50	.016	.020	6	
ø1	-	45°	-	45°		
			1	1		1

LEAD ASSIGNMENTS

<u>HEXFET</u> 1.- GATE 2.- DRAIN

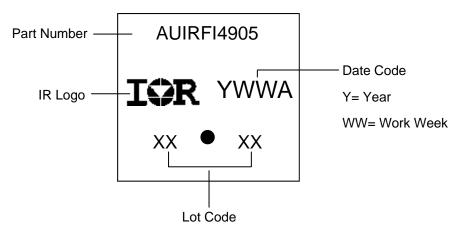
3.- SOURCE

IGBTs, CoPACK

1	GATE

2.- COLLECTOR 3.- EMITTER

TO-220 Full-Pak Part Marking Information

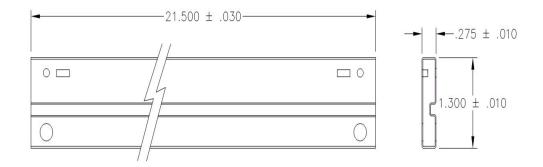


TO-220AB Full-Pak packages are not recommended for Surface Mount Application.

Note: For the most current drawing please refer to IR website at http://www.irf.com/package/



TO-220AB Full-Pak Tube Sketch



Qualification Information[†]

		Automotive (per AEC-Q101)			
Qualification Level		Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.			
Moisture Sensitivity Level		TO-220 Full-Pak	N/A		
	Machine Model	Class M4 (+/- 700V) ^{††}			
			AEC-Q101-002		
	Human Body Model		Class H2 (+/- 4000V) ^{††}		
ESD			AEC-Q101-001		
	Charged Device Model		Class C5 (+/- 2000V) ^{††}		
			AEC-Q101-005		
RoHS Compliant			Yes		

† Qualification standards can be found at International Rectifier's web site: <u>http://www.irf.com/</u>

†† Highest passing voltage.

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For technical support, please contact IR's Technical Assistance Center

http://www.irf.com/technical-info/

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